



Patents Form P5

Request for registration of a designated patent and grant of a standard patent

Patents Ordinance (Cap. 514)

Patents (General) Rules (Cap. 514C)

Patents (Transitional Arrangements) Rules (Cap. 514B)

Important notes

1. General notes:

- a. Please complete this form in English unless otherwise stated.
- b. This form must be signed and dated.
- c. If there is not enough space for any part on this form, please continue on an additional sheet. Number each additional sheet and state the number of additional sheet(s) in Part 07(a).
- d. Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk

2. Use of Personal data:

- a. The provision of your personal data is voluntary. However, the Patents Registry may be unable to handle your application, filing request or notice if you do not provide sufficient information.
- b. The Patents Registry will use any personal data provided in this form and any document(s) filed in relation to it for processing your application, request or notice, as well as for the purposes of collection set out at www.ipd.gov.hk/eng/home.htm. **Any of the information provided may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.**
- c. The Patents Registry may redact unsolicited personal data included with this form or any document(s) filed in relation to it before making them available for public inspection. Please **DO NOT provide any personal data (including personal data relating to third parties) which are not specifically required to be submitted.**
- d. Subject to the requirements of the Patents Ordinance, Cap. 514, any person has the right to request access to and correct his/her personal data held in the patent records maintained by the Patents Registry, pursuant to sections 18 and 22 of the Personal Data (Privacy) Ordinance, Cap. 486.
- e. For further details, please see the Personal Information Collection Statement at www.ipd.gov.hk/eng/home.htm.

3. Use of Other Information:

- a. The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out at www.ipd.gov.hk/eng/home.htm. **They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.**
- b. **DO NOT include any business information of your own or that of third parties which you consider to be confidential or commercially sensitive.** Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong, China. The fee schedule can be viewed at www.ipd.gov.hk/eng/forms_fees.htm. Payment can be made in person by cash, or by sending a cheque made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.

01 Your reference

02 Details of the corresponding request to record published Application no. Publication no. Date of publication (DD-MM-YYYY)	

03 Details of applicant <i>(If the name of the applicant is not in Roman letters or in Chinese, please include a transliteration in Roman letters.)</i>
Name
Name in Chinese <i>(if applicable)</i>
Address

04 Is the applicant the person named as the applicant for the Hong Kong SAR standard patent in the register? If you have marked "No", you need to submit a statement explaining the applicant's entitlement to apply for the grant of a standard patent and the prescribed documents supporting the statement. <i>(section 23(3)(b), Patents Ordinance and section 20, Patents (General) Rules, which can be viewed at www.ipd.gov.hk)</i>	<i>Please mark the appropriate box</i> <input type="checkbox"/> Yes <input type="checkbox"/> No
	Statement

Note 1 You must state the title of the invention in both English and Chinese.
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05 Title of invention <i>(Note 1)</i> English Chinese	

06 Details of designated patent (a) Publication no. (b) Date of grant (DD-MM-YYYY) (c) Date of publication (if different from the date of grant) (DD-MM-YYYY)	

07 Enter the no. of sheet(s) for any of the following documents you are filing with this form (a) Additional sheet(s) attached to this form (b) Copy of the published specification of the corresponding designated patent (c) Statement explaining the applicant's entitlement to apply and the prescribed documents supporting the statement (d) Others (please specify)	No. of sheet(s)

08 If a copy of the published specification of the corresponding designated patent is filed with this form, please confirm by marking the box	<i>Please mark if applicable</i>
	<input type="checkbox"/> I/We confirm that the attached copy of the specification is a true copy of the document issued by or kept at the relevant designated patent office.

Note 2 An address for service in Hong Kong, China must be supplied.
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09 Address for service in Hong Kong, China (Note 2) Name Address Telephone no. Facsimile no. E-mail address	

Note 3 If you are an agent, an address in Hong Kong, China where you reside or carry on your business activities must be supplied.

10 Agent's address (Note 3)	
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11 Signature

I/We confirm that I/we have read and understood the “Important notes” on page 1.

Signature

Name and Official Capacity of Signatory

Date (DD-MM-YYYY)